рнотосоирler **PS9821-1,-2**

HIGH CMR, 15 Mbps OPEN COLLECTOR OUTPUT TYPE 8-PIN SSOP (SO-8) 3.3 V HIGH-SPEED PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

NEC

The PS9821-1 and PS9821-2 are active-low type high-speed photocouplers that use a GaAlAs light-emitting diode on the input side and a photodetector IC that includes a photodiode and a signal processor on the same chip on the output side.

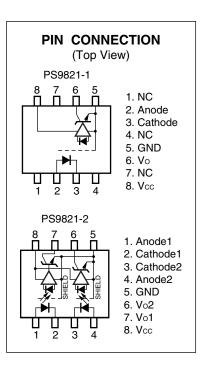
The PS9821-1, -2 are designed specifically for high common mode transient immunity (CMR) and low pulse width distortion, PS9821-2 is suitable for high density applications.

FEATURES

- Low power consumption (Vcc = 3.3 V)
- Pulse width distortion ($|t_{PHL}-t_{PLH}| = 35 \text{ ns MAX.}$)
- High common mode transient immunity (CMH, $C_{ML} = \pm 15 \text{ kV}/\mu \text{s MIN.}$)
- 40% reduction of mounting area (5-pin SOP × 2)
- High-speed (15 Mbps)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Open collector output
- Ordering number of tape product : PS9821-1-F3, F4: 1 500 pcs/reel
 - : PS9821-2-F3, F4: 1 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved No.40008347 (option)

APPLICATIONS

- Measurement equipment
- PDP
- FA Network



TRUTH TABLE

LED	Output
ON	L
OFF	Н

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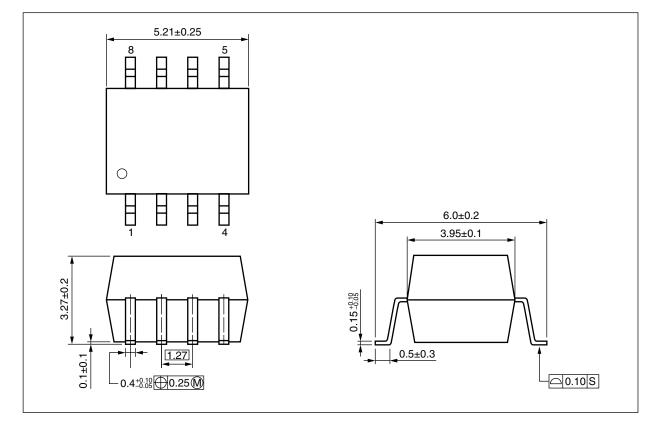
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The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

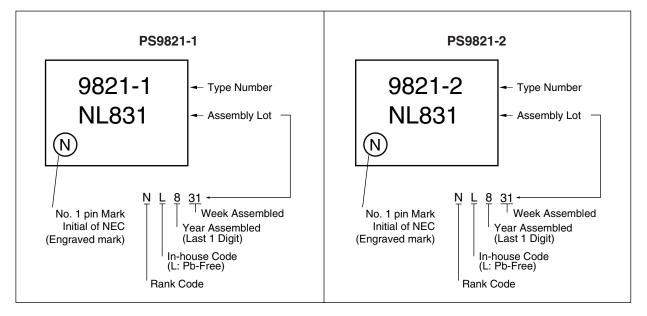
<R> PACKAGE DIMENSIONS (UNIT: mm)



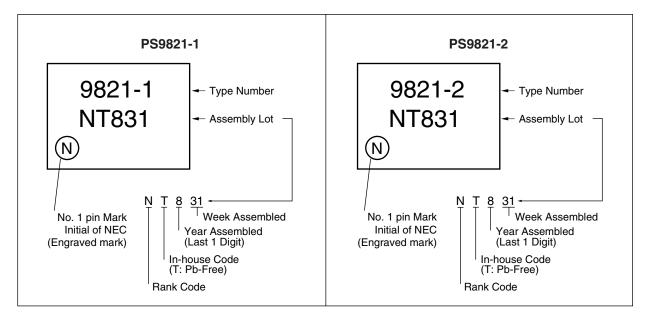
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<R> MARKING EXAMPLE

SnBi PLATING



Ni/Pd/Au PLATING



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number ^{*1}
PS9821-1	PS9821-1-A	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9821-1
PS9821-1-F3	PS9821-1-F3-A	(SnBi)	Embossed Tape 1 500 pcs/reel	(UL approved)	
PS9821-1-F4	PS9821-1-F4-A				
PS9821-2	PS9821-2-A		20 pcs (Tape 20 pcs cut)		PS9821-2
PS9821-2-F3	PS9821-2-F3-A		Embossed Tape 1 500 pcs/reel		
PS9821-2-F4	PS9821-2-F4-A				
PS9821-1-V	PS9821-1-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	PS9821-1
PS9821-1-V-F3	PS9821-1-V-F3-A		Embossed Tape 1 500 pcs/reel	(VDE0884 Part2)	
PS9821-1-V-F4	PS9821-1-V-F4-A			approved (Option)	
PS9821-2-V	PS9821-2-V-A		20 pcs (Tape 20 pcs cut)	-	PS9821-2
PS9821-2-V-F3	PS9821-2-V-F3-A		Embossed Tape 1 500 pcs/reel	-	
PS9821-2-V-F4	PS9821-2-V-F4-A				
PS9821-1	PS9821-1-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9821-1
PS9821-1-F3	PS9821-1-F3-AX	(Ni/Pd/Au)	Embossed Tape 1 500 pcs/reel	(UL approved)	
PS9821-1-F4	PS9821-1-F4-AX				
PS9821-2	PS9821-2-AX		20 pcs (Tape 20 pcs cut)		PS9821-2
PS9821-2-F3	PS9821-2-F3-AX		Embossed Tape 1 500 pcs/reel		
PS9821-2-F4	PS9821-2-F4-AX				
PS9821-1-V	PS9821-1-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	PS9821-1
PS9821-1-V-F3	PS9821-1-V-F3-AX		Embossed Tape 1 500 pcs/reel	(VDE0884 Part2)	
PS9821-1-V-F4	PS9821-1-V-F4-AX			approved (Option)	
PS9821-2-V	PS9821-2-V-AX		20 pcs (Tape 20 pcs cut)	1	PS9821-2
PS9821-2-V-F3	PS9821-2-V-F3-AX		Embossed Tape 1 500 pcs/reel	1	
PS9821-2-V-F4	PS9821-2-V-F4-AX				

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit				
			PS9821-1	PS9821-2					
Diode	Forward Current	lF	20*1	15 ^{*2}	mA				
	Reverse Voltage	VR	Ę	5	V/ch				
Detector	Supply Voltage	Vcc		7	V				
	Output Voltage	Vo	7		V/ch				
	Output Current	lo	25		mA/ch				
	Power Dissipation ³	Pc	40		mW/ch				
Isolation	Voltage *4	BV	2 500		2 500		Vr.m.s.		
Operating	g Ambient Temperature	TA	-40 to +85		-40 to +85		°C		
Storage	Temperature	Tstg	-55 to +125		-55 to +125		-55 to +125		°C

*1 Reduced to 0.3 mA/°C at $T_A = 60°C$ or more.

*2 Reduced to 0.1 mA/°C at $T_A = 60°C$ or more.

- *3 Applies to output pin Vo (collector pin). Reduced to 1.5 mW/°C at TA = 65° C or more.
- *4 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-4 shorted together, 5-8 shorted together.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage	VFL	0		0.8	V
High Level Input Current	Ігн	6.3	10	12.5	mA
Supply Voltage	Vcc	2.7		3.6	V
Pull-up Resistance	R∟	330		4 k	Ω
TLL (R _L = 1.0 k Ω , loads)	Ν			5	

ELECTRICAL CHARACTERISTICS (1/2) ($T_A = -40$ to +85°C, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP. [™]	MAX.	Unit
Diode	Forward Voltage	VF	$I_F = 10 \text{ mA}, T_A = 25^{\circ}C$	1.4	1.65	1.8	V
	Reverse Current	IR	$V_{R} = 3.0 V, T_{A} = 25^{\circ}C$			10	μA
	Terminal Capacitance	Ct	VF = 0 V, f = 1 MHz, TA = 25°C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 3.3 V, I⊧ = 0.8 mA		1	80	μA
			Vcc = Vo = 5.5 V, I⊧ = 0.8 mA		1*2		
	Low Level Output Voltage ³	Vol	$V_{CC} = 3.3 \text{ V}, \text{ I}_{\text{F}} = 5.0 \text{ mA}, \text{ I}_{\text{OL}} = 13 \text{ mA}$		0.2	0.6	V
			Vcc = 5.5 V, I⊧ = 5.0 mA, Io∟ = 13 mA		0.2 ^{*2}		
	High Level Supply Current	Іссн	$V_{CC} = 3.3 \text{ V}, \text{ I}_F = 0 \text{ mA}, \text{ V}_O = \text{open}$		4	7	mA
	(PS9821-1)		$V_{CC} = 5.5 \text{ V}, \text{ I}_F = 0 \text{ mA}, \text{ V}_O = \text{open}$		5 ^{*2}		
	High Level Supply Current		$V_{CC} = 3.3 \text{ V}, \text{ I}_F = 0 \text{ mA}, \text{ V}_O = \text{open}$		8	14	
	(PS9821-2)		$V_{CC} = 5.5 \text{ V}, \text{ I}_F = 0 \text{ mA}, \text{ V}_O = \text{open}$		10 ^{*2}		
	Low Level Supply Current	Iccl	$V_{CC} = 3.3 \text{ V}, \text{ I}_F = 10 \text{ mA}, \text{ V}_O = \text{open}$		7	10	
	(PS9821-1)		$V_{CC} = 5.5 \text{ V}, \text{ I}_F = 10 \text{ mA}, \text{ V}_O = \text{open}$		9 ^{*2}		
	Low Level Supply Current		$V_{CC} = 3.3 \text{ V}, \text{ I}_F = 10 \text{ mA}, \text{ V}_O = \text{open}$		14	20	
	(PS9821-2)		$V_{CC} = 5.5 \text{ V}, \text{ I}_F = 10 \text{ mA}, \text{ V}_O = \text{open}$		18 ^{*2}		
Coupled	Threshold Input Current	IFHL	$V_{CC} = 3.3 \text{ V}, \text{ V}_{\text{O}} = 0.8 \text{ V}, \text{ R}_{\text{L}} = 350 \ \Omega$		2.5	5	mA
	$(H \rightarrow L)$		$V_{CC} = 5 \text{ V}, \text{ Vo} = 0.8 \text{ V}, \text{ RL} = 350 \ \Omega$		2.5 ^{°2}		
	Isolation Resistance	RI-0	$\label{eq:VI-O} \begin{array}{l} V_{\text{I-O}} = 1 \ kV_{\text{DC}}, \ RH = 40 \ to \ 60\%, \\ T_{\text{A}} = 25^{\circ}\text{C} \end{array}$	10 ¹¹			Ω
	Insulation Resistance (Input-Input), (PS9821-2)	R⊦ı	$V_{I-I} = 1 \text{ kV}_{DC}$, $RH = 40 \text{ to } 60\%$, $T_A = 25^{\circ}C$	10 ¹⁰			Ω
	Isolation Capacitance	Сю	$V=0~V,~f=1~MHz,~T_{\text{A}}=25^{\circ}C$		0.6		pF
	Insulation Capacitance (Input-Input), (PS9821-2)	CI-I	$V = 0 V, f = 1 MHz, T_A = 25^{\circ}C$		0.3		pF
	Propagation Delay Time	t PHL	$T_A = 25^{\circ}C$		45	75	ns
	$(H \rightarrow L)^{*4}$		$V_{CC} = 3.3 \text{ V}, \text{ R}_{L} = 350 \Omega, \text{ I}_{F} = 7.5 \text{ mA}$			100	
			$V_{CC}=5~V,~R_L=350~\Omega,~I_F=7.5~mA$		38*2		
	Propagation Delay Time	tрьн	$T_A = 25^{\circ}C$		50	75	
	$(L \rightarrow H)^{*4}$		Vcc = 3.3 V, RL = 350 Ω, I⊧ = 7.5 mA			100	
			Vcc = 5 V, R∟ = 350 Ω, I⊧ = 7.5 mA		43 ^{*2}		
	Rise Time	tr	$V_{CC}=3.3~V,~R_{L}=350~\Omega,~I_{F}=7.5~mA$		20		
			Vcc = 5 V, R∟ = 350 Ω, I⊧ = 7.5 mA		20 ^{*2}		
	Fall Time	tr	$V_{CC}=3.3~V,~R_{L}=350~\Omega,~I_{F}=7.5~mA$		5		
			$V_{CC} = 5 \text{ V}, \text{ R}_{\text{L}} = 350 \ \Omega, \text{ I}_{\text{F}} = 7.5 \text{ mA}$		5 ^{*2}		1
	Pulse Width Distortion (PWD) *4	tplh-tphl	Vcc = 3.3 V, R∟ = 350 Ω, I⊧ = 7.5 mA		5	35	1
			Vcc = 5 V, R∟ = 350 Ω, I⊧ = 7.5 mA		5 ^{*2}		1
	Propagation Delay Skew	tрsк	Vcc = 3.3 V, R∟ = 350 Ω, I⊧ = 7.5 mA			40	

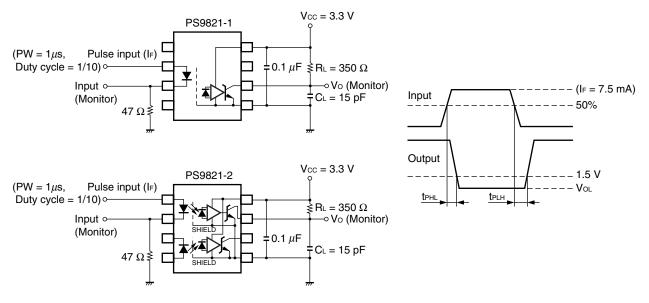
ELECTRICAL CHARACTERISTICS (2/2) (T_A = -40 to +85°C, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Coupled	Common Mode Transient Immunity at High	СМн		15	20		kV/ <i>µ</i> s
	Level Output ^{*s}				20 ^{*2}		
	Common Mode Transient Immunity at Low	CM∟		15	20		
	Level Output ¹⁵				20*2		

- ***1** Typical values at $T_A = 25^{\circ}C$
- *2 These values are reference values.

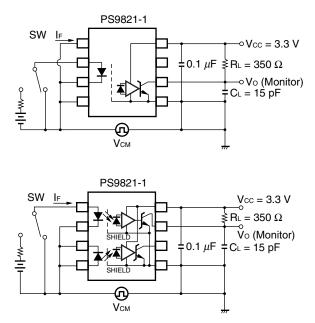
*3 Because VoL of 2 V or more may be output when LED current input and when output supply of Vcc = 2.6 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.

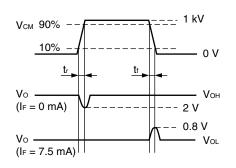
*4 Test circuit for propagation delay time



Remark CL includes probe and stray wiring capacitance.

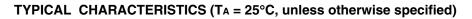
*5 Test circuit for common mode transient immunity

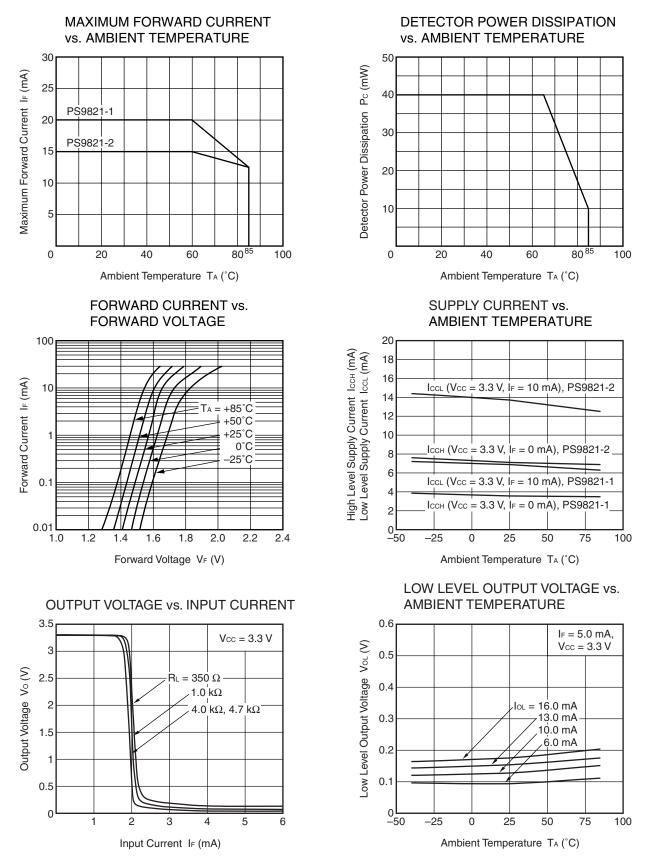




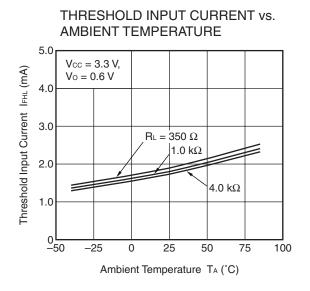
USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- **2.** By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

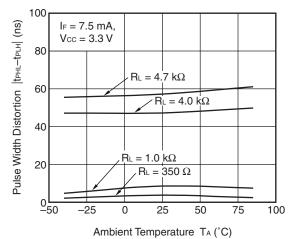




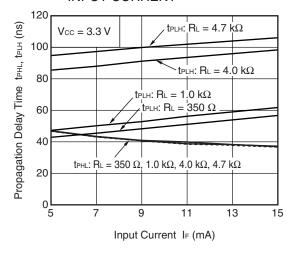
Remark The graphs indicate nominal characteristics.



PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

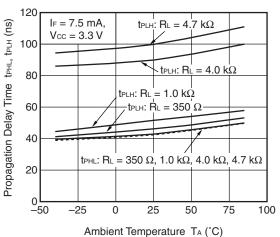


PROPAGATION DELAY TIME vs. INPUT CURRENT

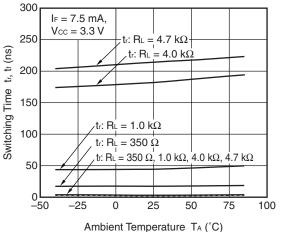


Remark The graphs indicate nominal characteristics.

PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE

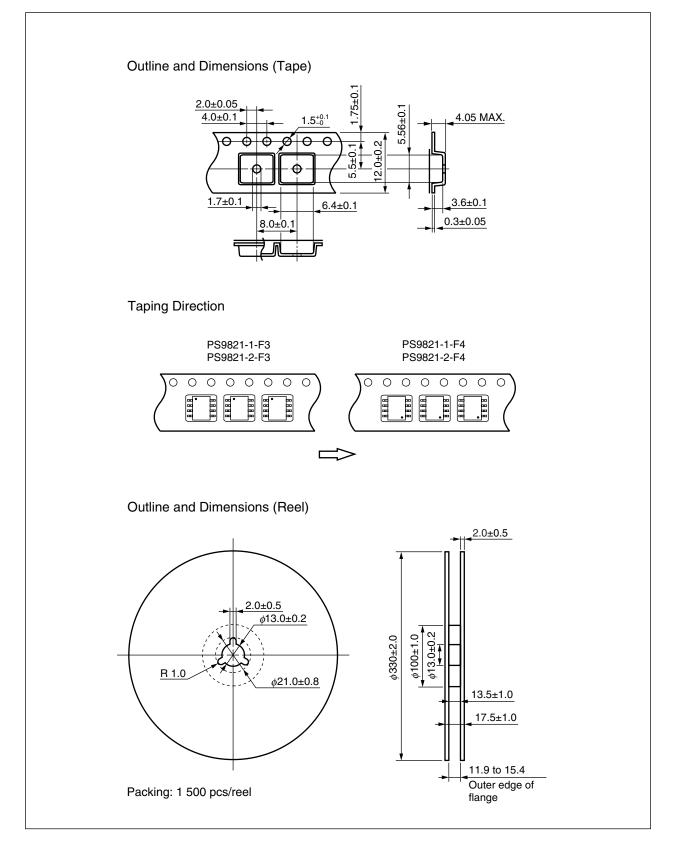


SWITCHING TIME vs. AMBIENT TEMPERATURE

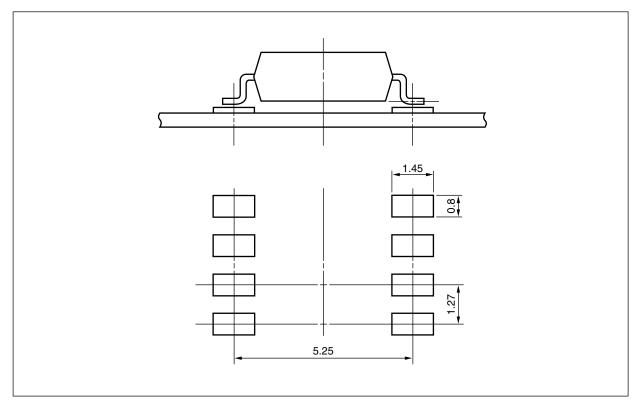




TAPING SPECIFICATIONS (UNIT: mm)







NOTES ON HANDLING

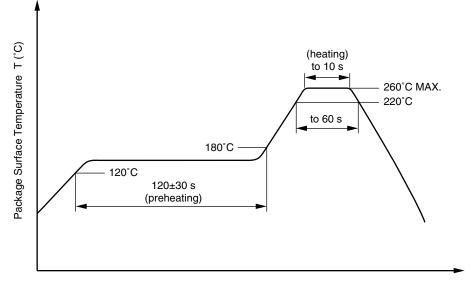
1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

 Peak temperature (lead part temperature) 	350°C or below
 Time (each pins) 	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100° C.

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN EN 60664-1 VDE0110 Part 1) for rated line voltages \leq 300 Vr.m.s. for rated line voltages \leq 600 Vr.m.s.		IV III	
Climatic test class (DIN EN 60664-1 VDE0110)		55/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{\text{IORM}}, P_{d} < 5 \text{ pC}$	Uiorm Upr	566 849	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices) U_{pr} = 1.875 \times U_{IORM}, P_d < 5 pC	Upr	1 061	V _{peak}
Highest permissible overvoltage	Utr	4 000	V _{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Clearance distance		>4.0	mm
Creepage distance		>4.0	mm
Comparative tracking index (DIN IEC 112/VDE 0303 Part 1)	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-40 to +85	°C
Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A MAX. at least 100^{\circ}\text{C}$	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current IF, Psi = 0) Power (output or total power dissipation)	Tsi Isi Psi	150 150 600	°C mA mW
Isolation resistance V _{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

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- "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
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(Note)

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Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.